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Part Number:

0678005005

Status:

Active

Overview:

serial_ata_products

Description:

1.27mm (.050") Pitch Serial ATA High Speed Header, Vertical, Surface Mount, with Locking Latch, 7 Circuits, 0.38µm (15µ") Gold (Au) Plating, for 1.60mm (.063") PCB, with PCB Locator Pegs, Lead-free

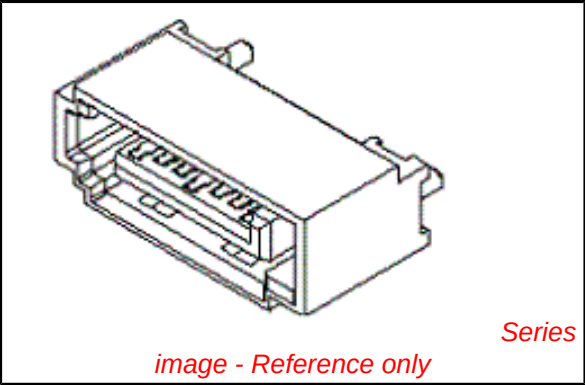
Documents:

3D Model

Drawing (PDF)

RoHS Certificate of Compliance (PDF)

Agency Certification	
CSA	LR 19980
UL	E29179
General	
Product Family	PCB Headers
Series	67800
Application	Board-to-Board, Wire-to-Board
Comments	Staggered Solder Pin Metal Post Length 2.65mm (.104")
Overview	serial_ata_products
Product Name	Serial ATA
Physical	
Breakaway	No
Circuits (Loaded)	7
Circuits (maximum)	7
Color - Resin	Black
Durability (mating cycles max)	50
First Mate / Last Break	Yes
Flammability	94V-0
Glow-Wire Compliant	No
Guide to Mating Part	No
Keying to Mating Part	Yes
Lock to Mating Part	Yes
Material - Metal	Brass
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Number of Rows	1
Orientation	Vertical
PCB Locator	Yes
PCB Retention	Yes
Packaging Type	Tray
Pitch - Mating Interface (in)	0.050 In
Pitch - Mating Interface (mm)	1.27 mm
Pitch - Term. Interface (in)	0.050 In
Pitch - Term. Interface (mm)	1.27 mm
Plating min: Mating (µin)	15
Plating min: Mating (µm)	0.38
Plating min: Termination (µin)	75
Plating min: Termination (µm)	1.9
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No



EU RoHS

ELV and RoHS

Compliant

REACH SVHC

Contains SVHC: No

Halogen-Free

Status

Halogen-Free

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com

For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

67800Series

Temperature Range - Operating
Termination Interface: Style

-35°C to +85°C
Surface Mount

Electrical

Current - Maximum per Contact
Voltage - Maximum

1.5A
15V DC

Solder Process Data

Lead-free Process Capability

Reflow Capable (SMT only)

Material Info

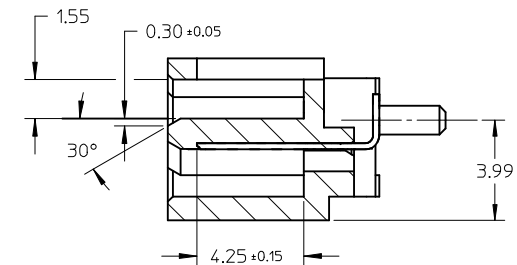
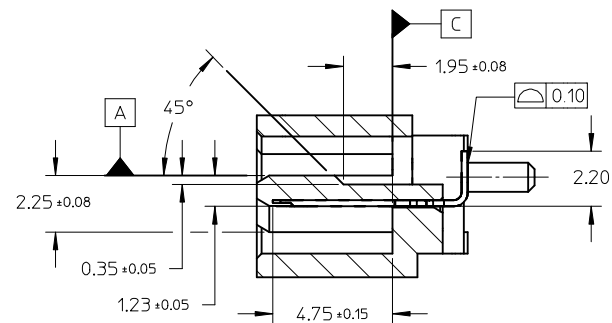
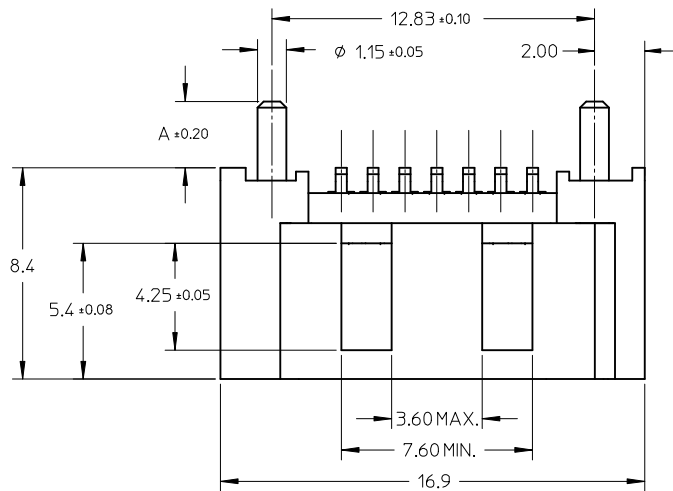
Reference - Drawing Numbers

Packaging Specification
Sales Drawing

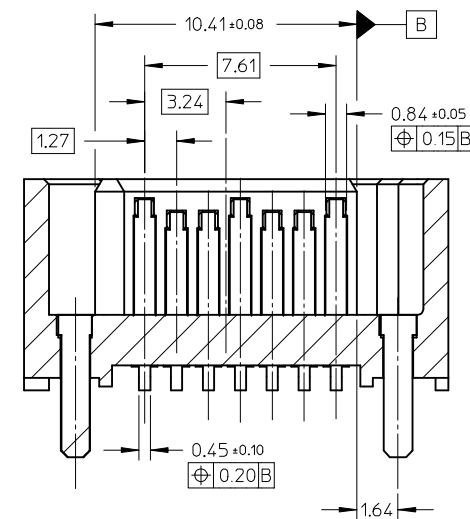
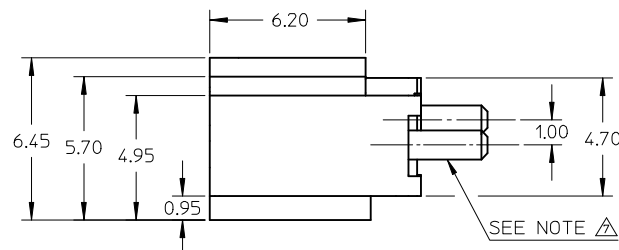
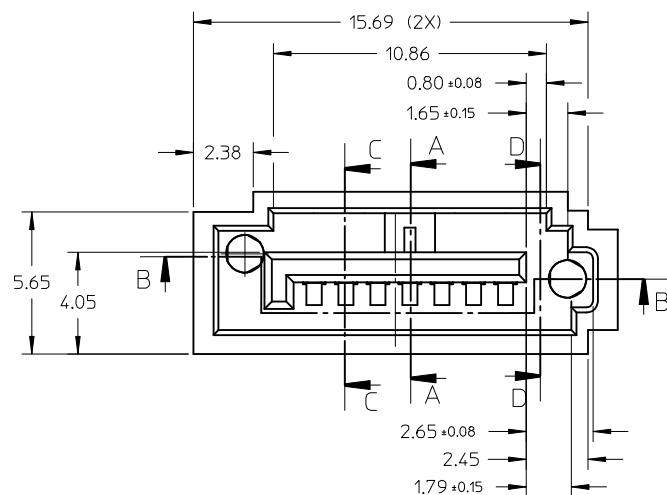
PK-67800-001
SD-67800-005

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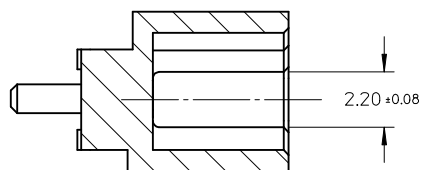
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SECTION C-C



SECTION B-B



SECTION D-D

REVISED EC NO: SH2010-0043 2009/08/07 TDRW:GLLI 2009/08/10 CHKD:XJONG 2009/09/13 APPR:RZHANG	DESCRIPTION	QUALITY SYMBOLS ▽=0 ◇=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
				mm	INCH	DRAWN BY GRATE MA	DATE 2004/02/02	TITLE HIGH SPEED CONNECTOR 1.27MM PITCH VERTICAL SMT SOLDER TAIL		
			4 PLACES	± ---	± ---	CHECKED BY YAJUN	DATE 2004/02/02			
			3 PLACES	± ---	± ---					
			2 PLACES	± 0.15	± ---					
			1 PLACE	± 0.25	± ---	APPROVED BY SAM	DATE 2004/02/02	MOLEX INCORPORATED		
			ANGULAR ± 1 °			MATERIAL NO.	DOCUMENT NO.	SHEET NO.		
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SEE SHEET 2		SD-67800-005		1 OF 2
	REV		SIZE A3			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

10 9 8 7 6 5 4 3 2 1

NOTES:

1. MATERIAL:

HOUSING: HIGH TEMPERATURE THERMAL PLASTIC, GLASS FILLED,
UL94V-0, COLOR: REFER TO CHART.

TERMINAL: BRASS

POST: BRASS

2. TERMINAL PLATING:

CONTACT AREA: (a) GOLD FLASH

(b) GOLD, THICKNESS=0.76 MICRON MINIMUM

(C) GOLD, THICKNESS=0.38 MICRON MINIMUM

SOLDER TAIL: TIN, THICKNESS=1.27 MICRON MINIMUM

UNDER PLATE: NICKEL PLATED, THICKNESS=1.27 MICRON MINIMUM

3. POST PLATING: UNDER PLATE: NICKEL, THICKNESS=1.25 MICRON MINIMUM

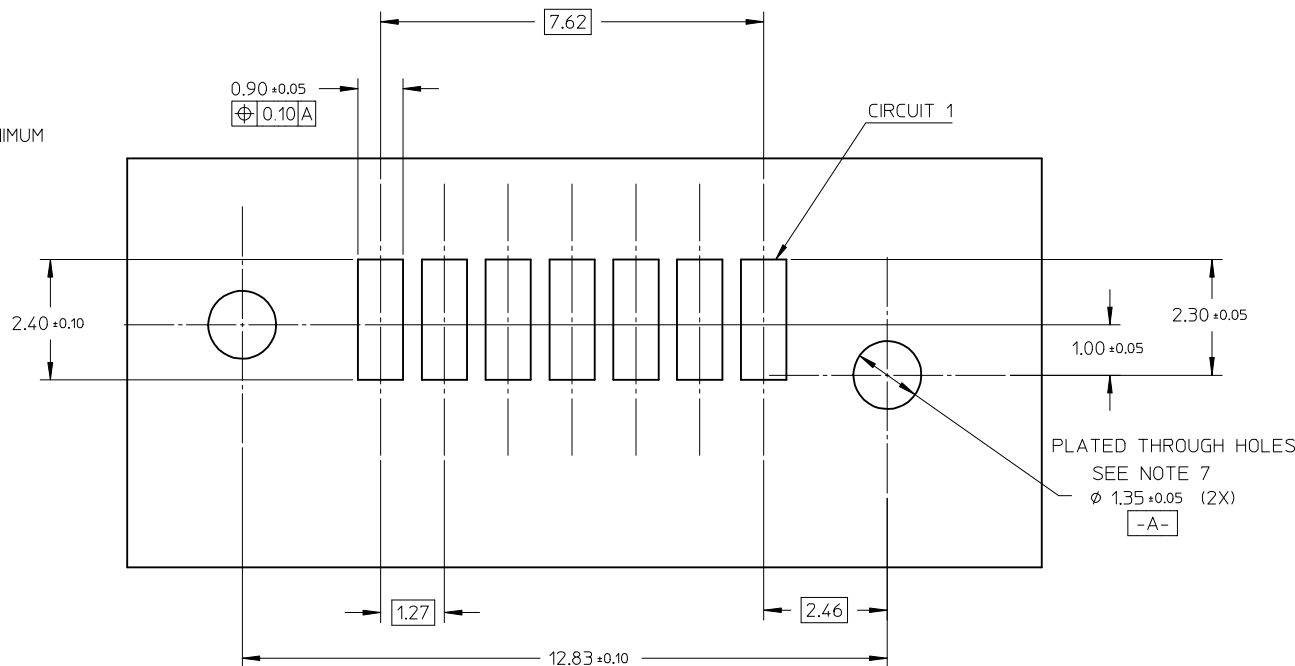
TIN, THICKNESS=1.9 MICRON MINIMUM OVER ALL

4. PACKAGING: PK-67800-001

5. PRODUCT SPECIFICATION REFER TO PS-67491-001

6. RECOMMENDED SOLDERING PROCESS: IR PROCESS

△ METAL POSTS TO BE SOLDERED TO PCB



RECOMMENDED P.C.B LAYOUT
CONNECTOR SIDE

678005025	SEE NOTE2(c)	BLACK	3.45	PURE TIN
678005022	SEE NOTE2(b)			
678005021	SEE NOTE2(a)			
678005015	SEE NOTE2(c)	BLACK	3.05	
678005012	SEE NOTE2(b)			
678005011	SEE NOTE2(a)			
678005005	SEE NOTE2(c)	BLACK	2.65	
678005004	SEE NOTE2(c)	YELLOW		
678005003	SEE NOTE2(c)	BLUE		
678005002	SEE NOTE2(b)	BLACK		
678005001	SEE NOTE2(a)			
MATERIAL NO	PLATING TYPE	HOUSING COLOR	DIM A	REMARK

REVISED EC NO: SH2010-0043 2009/08/07 DRAWN:GLLI 2009/08/10 CHKD:XJSONG 2009/09/13 APPR:RZHANG	DESCRIPTION	QUALITY SYMBOLS ▽=0 ◇=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION
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					SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		